

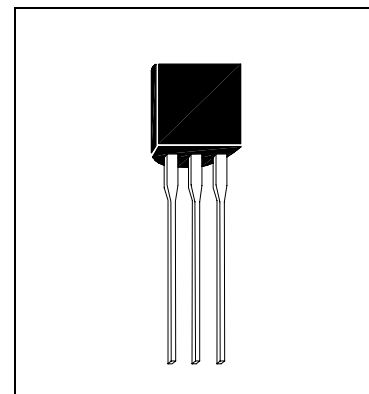


HBF423

PNP EPITAXIAL PLANAR TRANSISTOR

Description

Video B-class Power stages in TV-receivers



Absolute Maximum Ratings

- Maximum Temperatures
Storage Temperature -55 ~ +150 °C
Junction Temperature +150 °C Maximum
- Maximum Power Dissipation
Total Power Dissipation (Ta=25°C) 830 mW
- Maximum Voltages and Currents (Ta=25°C)
VCBO Collector to Base Voltage -250 V
VCEO Collector to Emitter Voltage -250 V
VEBO Emitter to Base Voltage -5 V
IC Collector Current -50 mA

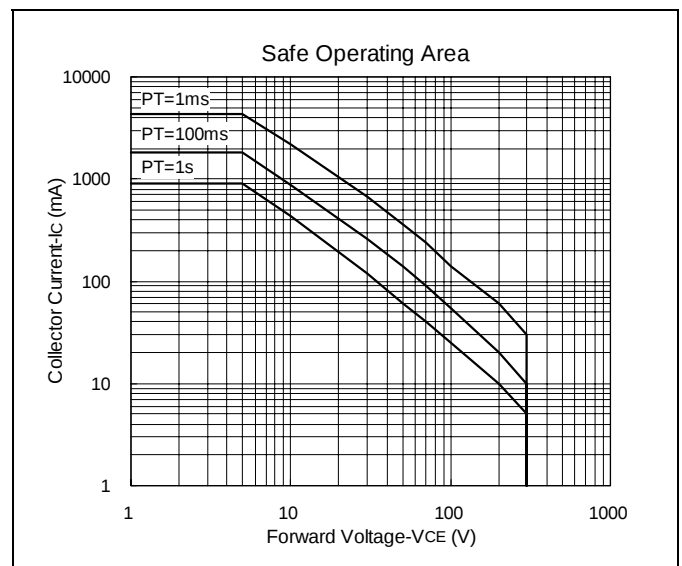
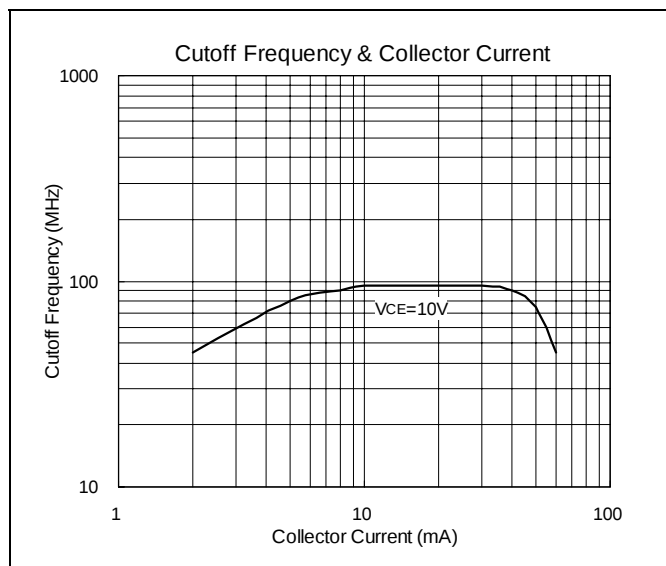
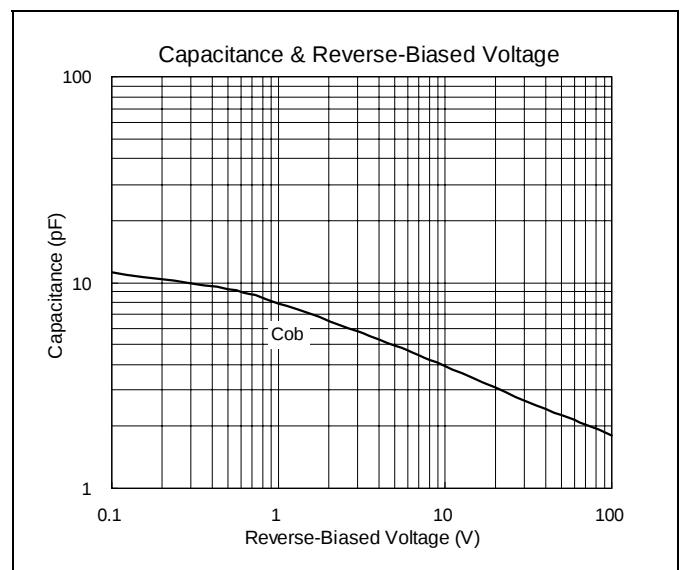
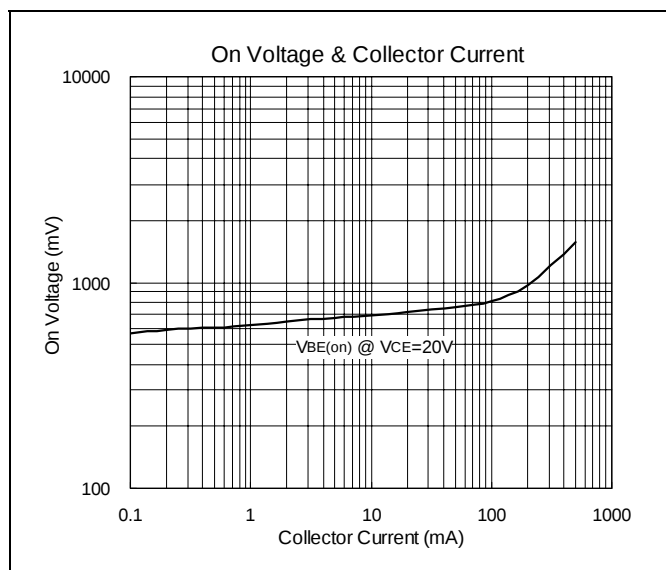
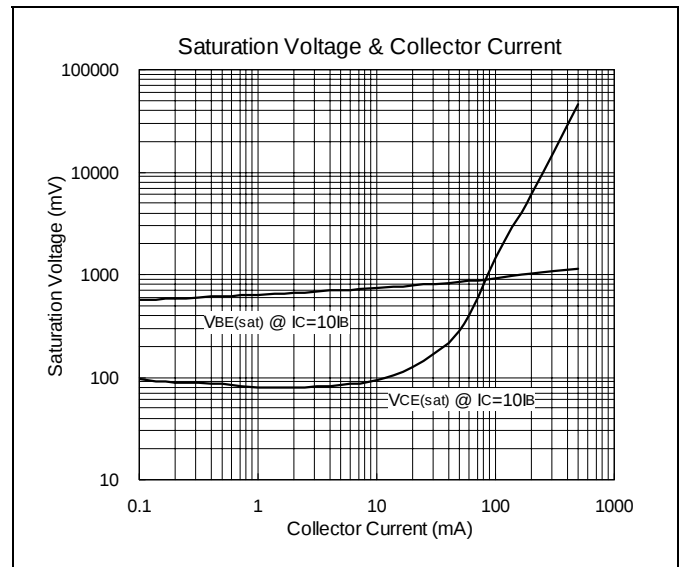
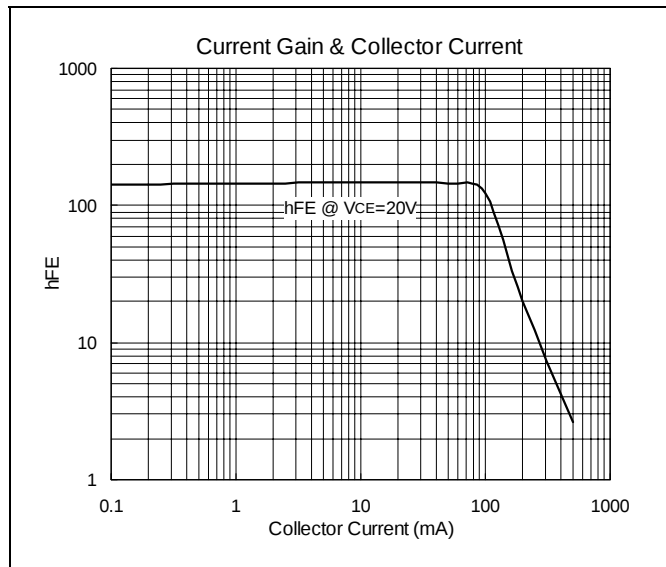
Characteristics (Ta=25°C)

Symbol	Min.	Typ.	Max.	Unit	Test Conditions
BVCBO	-250	-	-	V	IC=-100uA, IE=0
BVCEO	-250	-	-	V	IC=-1mA, IB=0
BVEBO	-5	-	-	V	IE=-10uA, IC=0
ICBO	-	-	-100	nA	VCB=-200V, IE=0
IEBO	-	-	-10	uA	VEB=-5V, IE=0
*VCE(sat)	-	-	-0.6	V	IC=-30mA, IB=-3mA
*hFE	50	-	-		VCE=-20V, IC=-25mA
fT	60	-	-	MHz	IE=-10mA, VCE=-10V, f=100MHz

*Pulse Test : Pulse Width ≤380us, Duty Cycle≤2%

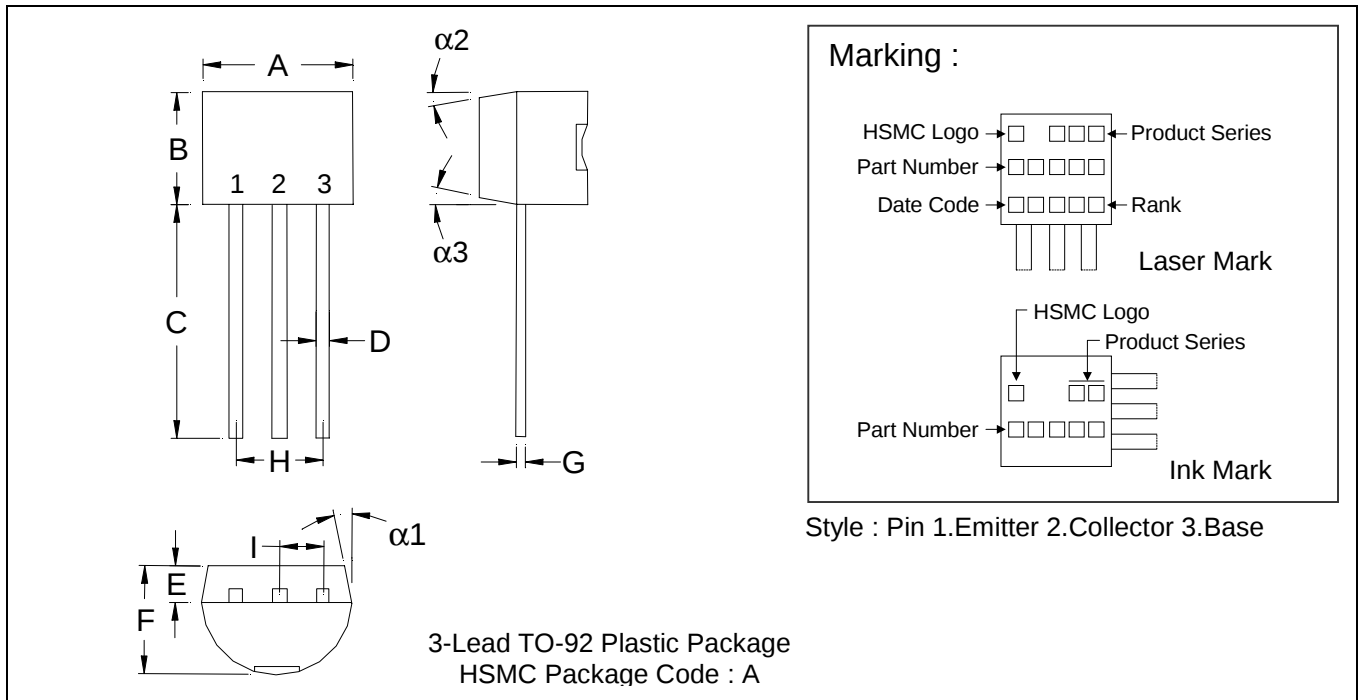


Characteristics Curve





TO-92 Dimension



*:Typical

DIM	Inches		Millimeters		DIM	Inches		Millimeters	
	Min.	Max.	Min.	Max.		Min.	Max.	Min.	Max.
A	0.1704	0.1902	4.33	4.83	G	0.0142	0.0220	0.36	0.56
B	0.1704	0.1902	4.33	4.83	H	-	*0.1000	-	*2.54
C	0.5000	-	12.70	-	I	-	*0.0500	-	*1.27
D	0.0142	0.0220	0.36	0.56	α1	-	*5°	-	*5°
E	-	*0.0500	-	*1.27	α2	-	*2°	-	*2°
F	0.1323	0.1480	3.36	3.76	α3	-	*2°	-	*2°

Notes : 1.Dimension and tolerance based on our Spec. dated Apr. 25,1996.

2.Controlling dimension : millimeters.

3.Maximum lead thickness includes lead finish thickness, and minimum lead thickness is the minimum thickness of base material.

4.If there is any question with packing specification or packing method, please contact your local HSMC sales office.

Material :

- Lead : 42 Alloy ; solder plating
- Mold Compound : Epoxy resin family, flammability solid burning class:UL94V-0

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